Reverse annealing studies on standard diodes irradiated with 34 MeV proton beam.

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Outline

- Structures description;
- irradiation conditions;
- measurements of diode leakage current \rightarrow k factor estimation;
- measurements of depletion voltage as a function of fluence and annealing time \rightarrow annealing parameters;
- study of Bistable effect on diode leakage current and depletion voltage → time constant;
- conclusions

Structures description – Irradiation

Characterisation before and after irradiation of:

• Diodes: p+/n

0.24*0.24 cm² 300 µm thick

• Baby detectors: 128 strips p+

3.22 cm long - 61 µm pitch

Built on two different kind of standard substrates:

 Low resistivity: 1.5 -2 KΩcm Crystal orientation <100>
 High resistivity : 6 -10 KΩcm Crystal orientation <111>
 HR <111>

Irradiated with

• <u>**34 MeV protons</u>**, at **4** different fluences, up to 10¹⁴ pcm⁻², at the Cyclotron of the Research Centre of Karlsruhe **FZK** (Germany)</u>

Characterisation of the samples (*)

Before Irradiation C/V and I/V on all samples.

After 34 MeV proton irradiation

- diode <u>leakage current</u>
- diode <u>depletion voltage</u> vs. Φ^{N}
- ΔN_{eff} vs. annealing time
- V_{dep} and I_{leak} vs. time after heating 80°C $\rightarrow \tau$

 $\rightarrow \Phi^{N} \rightarrow k$ $\rightarrow \beta$ $\rightarrow ann. parameters$ $\rightarrow -$

(*) All the measurements of I/V and C/V were performed on diodes with guard ring to 0V

Measurements

After 34 MeV proton irradiation the structures were kept at $0^{\circ}C$;

Measurements performed:

• *during* 10 days of annealing at $T_a = 22 \pm 1^{\circ}C$

After benefical annealing the structures were kept for ~ 1y at $0^{\circ}C$;

Measurements performed:

- *during* 95 hours of annealing at $T_a = 60$ and $80^{\circ}C$
- *during* 98 hours of annealing at $T_a = 120^{\circ}C$

All the measurements were performed at $T_m = 22 \pm 1 \ ^0C \rightarrow T = 21 \ ^0C$

$$\Delta I = \alpha \left(t, T_a \right) \cdot \Phi^N \cdot V$$

$$\alpha^{short}(t,T_a) = \alpha_{\infty} \sum_{i} \frac{b_i}{b_{\infty}} \cdot e^{\left(-\frac{t}{\tau_i(T_a)}\right)} (*)$$

$$\alpha^{long}(t) = \alpha_I \cdot e^{-\frac{t}{\tau_I}} + \alpha_0 - \beta \cdot \ln\left(\frac{t}{t_0}\right)^{(*)}$$

We can determine the hardness factor $\rightarrow k = \Phi^N / \Phi^P$

*) Standard parameterisation for $\alpha(t, \Phi)$ and parameters value from M. Moll PhD thesis

Diode leakage current vs. annealing time at 20°C



HR<111>



24 GeV/c proton irradiation



The effective doping concentration N_{eff}

$$N_{eff}^{\Phi} = N_{eff}^{0} - N_{A}(\Phi, t(T_{a})) - N_{C}(\Phi) - N_{Y}(\Phi, t(T_{a}))$$

Short term annealing: $N_A = g_A \Phi \cdot e^{-t/\tau_A}$

Stable damage component:
$$N_C = N_{C0} (1 - e^{-C\Phi}) + g_C \cdot \Phi$$

 $N_Y = g_Y \Phi \cdot (1 - e^{-t/\tau_Y})$ first order process
Long term annealing: $N_Y = g_Y \Phi \cdot (1 - \frac{1}{1 + t/\tau_Y})$ second order process: with τ_Y ind. on Φ
 $N_Y = g_Y \Phi \cdot (1 - \frac{1}{1 + k_2 g_Y \Phi t})$ second order process: with $\tau_Y \propto 1/\Phi$

N_{eff} vs. Φ :

For a fixed annealing time t at the minimum of the ann. curve: $\tau_A \ll t \ll \tau_Y$

$$N_{eff}^{\Phi} = N_{eff}^{0} - N_{C0} (1 - e^{-C\Phi}) - \beta \cdot \Phi$$

• **Proton** irradiation: $N_{C0} \cong N_{eff}^{0}$ \leftarrow *Complete donor removal*

$$N_{eff}^{\Phi} = N_{eff}^{0} e^{-C\Phi} - \beta \cdot \Phi \xrightarrow{High\Phi} - \beta \cdot \Phi \xrightarrow{} \beta \approx g_{C}$$

For a fixed annealing time t at the maximum of the ann. curve: $t \gg \tau_y$

$$N_{eff}^{\Phi} = N_{eff}^{0} e^{-C\Phi} - (g_C + g_Y) \cdot \Phi \xrightarrow{High\Phi} - \beta' \cdot \Phi$$

$$\beta' = g_C + g_Y$$

V_{dep} vs. fluence



FIT- second order process with $\tau_v \propto 1/\Phi$



 $\overline{g}_{Y} = 7.8 \cdot 10^{-2} \, cm^{-1}$ $\overline{g}_{C} = 1.3 \cdot 10^{-2} \, cm^{-1}$ $(g_{C}(\Phi_{1}) = 4.5 \cdot 10^{-2} \, cm^{-1})$

Similar to the 24 GeV values

 $\overline{g}_{Y} = 8.2 \cdot 10^{-2} cm^{-1}$ $\overline{g}_{C} = 1.3 \cdot 10^{-2} cm^{-1}$



I_{leak} vs. relaxation time HR<111> Φ_4

The measurement of leakage current vs time $(V_{bias}=400V)$ starts immediately after the heating at 80°C.

The measurement of leakage current vs time $(V_{bias}=400V)$ starts after 24 hours from the heating.



I_{leak} vs. relaxation time HR <111>



I_{leak} vs. relaxation time LR <100>



 $\tau = 12 \cdot 10^3 s$ 3.3 hours

V_{dep} vs. relaxation time HR <111>



$$\tau = 11 \cdot 10^3 s$$
 \longrightarrow 3 hours

V_{dep} vs. relaxation time LR <100>



$$\tau = 13 \cdot 10^3 s$$
 3.5 hours

Conclusions

• As expected, leakage current doesn't depend on the substrate resistivity and orientation.

• The measurement of I_{leak} vs. annealing time allows a good estimation of Φ^N and a determination of the k factors both for 34 MeV and for 24 GeV/c protons. We have extracted:

k=1.3±0.3 for 34 MeV proton irradiation \rightarrow less than the theoretical value of (**k=0.63±0.07** for 24 GeV/c proton irradiation) kth ~ 2 obtained from displacement damage function (NIEL hypothesis)

• As for high energy protons, also for 34 MeV proton irradiation N_{eff}^{Φ} is characterized by a **complete donor removal.**

• The **annealing parameters** were extracted for 34 MeV proton irradiation after the complete relaxation of the bistable defects, using the II order - fluence depending- parameterisation.

• Both current and depletion voltage relaxation time constants have been estimated for the full samples heated at 80^oC and $\tau_{rel} < 3.5$ hours.







FIT- second order process with τ_y const.



